## 2SA1739

## Silicon PNP epitaxial planar type

## For high speed switching <br> Complementary to 2SC3938

## Features

- High speed switching
- Low collector-emitter saturation voltage $\mathrm{V}_{\mathrm{CE} \text { (sat) }}$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

Absolute Maximum Ratings $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$

| Parameter | Symbol | Rating | Unit |
| :--- | :---: | :---: | :---: |
| Collector-base voltage (Emitter open) | $\mathrm{V}_{\text {CBO }}$ | -15 | V |
| Collector-emitter voltage (Base open) | $\mathrm{V}_{\text {CEO }}$ | -15 | V |
| Emitter-base voltage (Collector open) | $\mathrm{V}_{\text {EBO }}$ | -4 | V |
| Collector current | $\mathrm{I}_{\mathrm{C}}$ | -50 | mA |
| Peak collector current | $\mathrm{I}_{\mathrm{CP}}$ | -100 | mA |
| Collector power dissipation | $\mathrm{P}_{\mathrm{C}}$ | 150 | mW |
| Junction temperature | $\mathrm{T}_{\mathrm{j}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |



Marking Symbol: AX

Electrical Characteristics $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C} \pm 3^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: |
| Collector-base cutoff current (Emitter open) | $\mathrm{I}_{\mathrm{CBO}}$ | $\mathrm{V}_{\mathrm{CB}}=-8 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ |  |  | -0.1 | $\mu \mathrm{~A}$ |
| Emitter-base cutoff current (Collector open) | $\mathrm{I}_{\mathrm{EBO}}$ | $\mathrm{V}_{\mathrm{CE}}=-3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=0$ |  |  | -0.1 | $\mu \mathrm{~A}$ |
| Forward current transfer ratio | $\mathrm{h}_{\mathrm{FE} 1}{ }^{*}$ | $\mathrm{~V}_{\mathrm{CE}}=-1 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-10 \mathrm{~mA}$ | 50 |  | 150 | - |
|  | $\mathrm{h}_{\mathrm{FE} 2}$ | $\mathrm{~V}_{\mathrm{CE}}=-1 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-1 \mathrm{~mA}$ | 30 |  |  |  |
| Collector-emitter saturation voltage | $\mathrm{V}_{\mathrm{CE}(\text { sat })}$ | $\mathrm{I}_{\mathrm{C}}=-10 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=-1 \mathrm{~mA}$ |  | -0.1 | -0.2 | V |
| Transition frequency | $\mathrm{f}_{\mathrm{T}}$ | $\mathrm{V}_{\mathrm{CB}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=10 \mathrm{~mA}, \mathrm{f}=200 \mathrm{MHz}$ | 800 | 1500 |  | MHz |
| Collector output capacitance <br> (Common base, input open circuited) | $\mathrm{C}_{\mathrm{ob}}$ | $\mathrm{V}_{\mathrm{CB}}=-5 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}=1 \mathrm{MHz}$ |  | 1 |  | pF |
| Turn-on time | $\mathrm{t}_{\mathrm{on}}$ | Refer to the switching time |  | 12 |  | ns |
| Turn-off time | $\mathrm{t}_{\text {off }}$ | measurement circuit |  | 20 |  | ns |
| Storage time | $\mathrm{t}_{\mathrm{stg}}$ |  | 19 |  | ns |  |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
2. *: Rank classification

| Rank | Q | R | No-rank |
| :---: | :---: | :---: | :---: |
| $\mathrm{h}_{\mathrm{FE} 1}$ | 50 to 120 | 90 to 150 | 50 to 150 |
| Marking symbol | AXQ | AXR | AX |

Product of no-rank is not classified and have no marking symbol for rank.

Switching time measurement circuit

$$
\mathrm{t}_{\mathrm{on}}, \mathrm{t}_{\text {off }} \text { Test circuit }
$$

$\mathrm{t}_{\text {stg }}$ Test circuit

$\mathrm{V}_{\text {IN }}=-5.8 \mathrm{~V} \quad \mathrm{~V}_{\text {IN }}=9.8 \mathrm{~V}$
$\mathrm{V}_{\mathrm{BB}}=$ Ground $\quad \mathrm{V}_{\mathrm{BB}}=-8.0 \mathrm{~V}$


$$
\mathrm{V}_{\mathrm{IN}}=9.0 \mathrm{~V}
$$






Emitter current $I_{E}(m A)$


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